



P-Channel Enhancement-Mode Vertical DMOS FETs

Ordering Information

BV _{DSS} /	R _{DS(ON)} (max)	V _{GS(th)} (max)	I _{D(ON)} (min)	Order Number / Package			
BV _{DGS}				SO-8	TO-92	Die [†]	
-350V	15Ω	-2.0V	-0.7A	_	TP2635N3	_	
-400V	15Ω	-2.0V	-0.7A	TP2640LG	TP2640N3	TP2640ND	

[†]MIL visual screening available.

Features

- Low threshold -2.0V max.
- High input impedance
- Low input capacitance
- Fast switching speeds
- Low on resistance
- Free from secondary breakdown
- Low input and output leakage
- Complementary N- and P-channel devices

Applications

- Logic level interfaces ideal for TTL and CMOS
- Solid state relays
- Battery operated systems
- ☐ Photo voltaic drives
- Analog switches
- General purpose line drivers
- Telecom switches

Absolute Maximum Ratings

Drain-to-Source Voltage	BV_{DSS}
Drain-to-Gate Voltage	BV_{DGS}
Gate-to-Source Voltage	± 20V
Operating and Storage Temperature	-55°C to +150°C
Soldering Temperature*	300°C

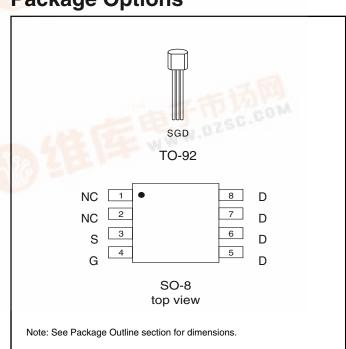
Distance of 1.6 mm from case for 10 seconds.

Low Threshold DMOS Technology

These low threshold enhancement-mode (normally-off) transistors utilize a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

Package Options



Thermal Characteristics

Package	I _D (continuous)*	I _D (pulsed)	Power Dissipation @ T _C = 25°C	θ _{jc} °C/W	θ _{ja} °C/W	I _{DR} *	I _{DRM}
SO-8	-210mA	-1.25A	1.3W [†]	24	96 [†]	-210mA	-1.25A
TO-92	-180mA	-0.8A	1.0W	125	170	-180mA	-0.8A

^{*} I_D (continuous) is limited by max rated T_{j} .

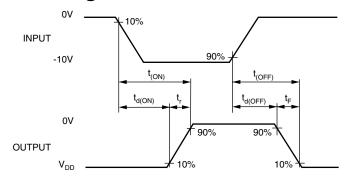
Electrical Characteristics (@ 25°C unless otherwise specified)

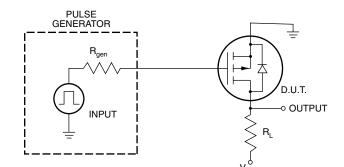
Symbol	Parameter		Min	Тур	Max	Unit	Conditions	
BV _{DSS}	Drain-to-Source	TP2640	-400			V	$V_{GS} = 0V, I_{D} = -2.0mA$	
	Breakdown Voltage	TP2635	-350					
V _{GS(th)}	Gate Threshold Voltage		-0.8		-2.0	V	$V_{GS} = V_{DS}$, $I_D = -1.0$ mA	
$\Delta V_{GS(th)}$	Change in V _{GS(th)} with Tempera	ature			5.0	mV/°C	$V_{GS} = V_{DS}$, $I_D = -1.0$ mA	
I _{GSS}	Gate Body Leakage				-100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
I _{DSS}					-1	μА	V _{GS} = 0V, V _{DS} = -100V	
					-10	μА	V _{GS} = 0V, V _{DS} = Max Rating	
					-1	mA	V_{GS} = 0V, V_{DS} = 0.8 Max Rating T_A = 125°C	
I _{D(ON)}	ON-State Drain Current		0.7			Α	$V_{GS} = -10V, V_{DS} = -25V$	
R _{DS(ON)}	R _{DS(ON)} Static Drain-to-Source ON-State Resistance			12	15	Ω	$V_{GS} = -2.5V, I_{D} = -20mA$	
				11	15		$V_{GS} = -4.5V, I_{D} = -150mA$	
				11	15		$V_{GS} = -10V, I_D = -300mA$	
$\Delta R_{DS(ON)}$	Change in R _{DS(ON)} with Temperature				0.75	%/°C	$V_{GS} = -10V, I_D = -300mA$	
G _{FS}	Forward Transconductance		200			m&	$V_{DS} = -25V, I_{D} = -300mA$	
C _{ISS}	Input Capacitance				300	pF	$V_{GS} = 0V, V_{DS} = -25V$ f = 1 MHz	
C _{OSS}	Common Source Output Capacitance				50			
C _{RSS}	Reverse Transfer Capacitance	Reverse Transfer Capacitance			12			
t _{d(ON)}	Turn-ON Delay Time				10	ns	$V_{DD} = -25V$, $I_{D} = -300$ mA, $R_{GEN} = 25\Omega$	
t _r	Rise Time				15			
t _{d(OFF)}	Turn-OFF Delay Time				60			
t _f	Fall Time				40		GEN	
V _{SD}	Diode Forward Voltage Drop				-1.8	V	$V_{GS} = 0V, I_{SD} = -200 \text{mA}$	
t _{rr}	Reverse Recovery Time			300		ns	$V_{GS} = 0V, I_{SD} = -200 \text{mA}$	

Notes

- 1. All D.C. parameters 100% tested at $25^{\circ}C$ unless otherwise stated. (Pulse test: $300\mu s$ pulse, 2% duty cycle.)
- 2. All A.C. parameters sample tested.

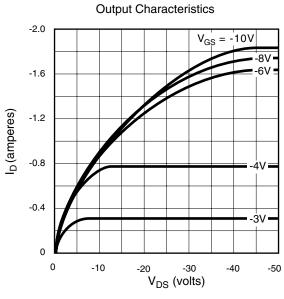
Switching Waveforms and Test Circuit

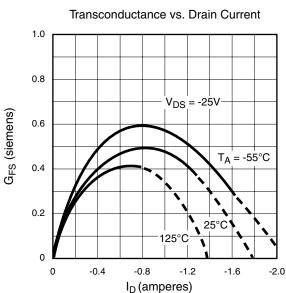


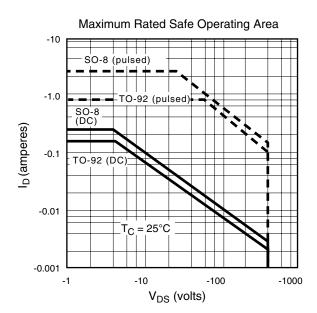


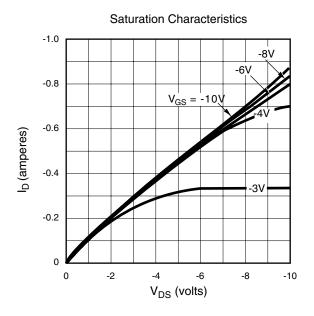
[†] Mounted on FR4 board, 25mm x 25mm x 1.57mm.

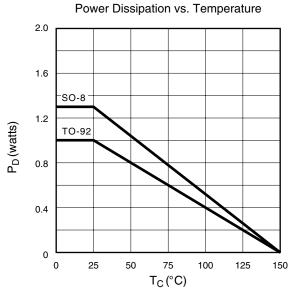
Typical Performance Curves

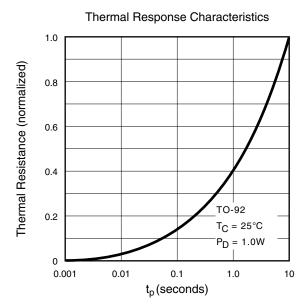












Typical Curves

